1、设备为金属外壳时VGA外壳要与PGND直接连接; 2、磁珠、电容的选用参数根据实际测试结果来调整。 BV03C D4 BV05C J3A BV05C BV03C BV03C L1 FBMA-11-160808-1217 DGND DGND VSYNC FBMA-11-160808-121T L102 FBMA-11-160808-121T VGA5V VGA B+ **HSYNC** L101 FBMA-11-160808-121T 33pF C6 DDCSDA VGA_G-33pF L100 FBMA-11-160808-121T 33pF 33pF C10 C11 C12 33pF33pF 33pF 33pF 33pF 33pF DGND **DGND** 一站式电磁兼容(EMC)方案供应商 PON 电话: 钟凯13632524150; 0755-2653²²285 邮箱: kai.zhong@compon-tech.com Document Number Rev Compon2011 1.0 Wednesday, October 26, 2011 Date: